

6A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- High surge current capability
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

| ΔD | DI | ICA | TI | 0 | NS. |
|------------|--------------|-----|----|---|------|
| AF | \mathbf{r} | | | u | 14-2 |

- DC to DC converter
- Automotive application
- Car lighting
- Snubber

MECHANICAL DATA

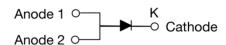
- Case: TO-277A (SMPC4.6U)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.107g (approximately)

| KEY PARAMETERS | | | | |
|-------------------|--------------------|----|--|--|
| PARAMETER VALUE U | | | | |
| I _F | 6 | Α | | |
| V_{RRM} | 200 - 1000 | V | | |
| I _{FSM} | 140 | Α | | |
| T_{JMAX} | 150 | °C | | |
| Package | TO-277A (SMPC4.6U) | | | |
| Configuration | Single die | | | |





TO-277A (SMPC4.6U)



| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted) | | | | | | | | |
|--|------|------------------|-------------|-------------|-------------|-------------|-------------|------|
| PARAMETER | | SYMBOL | TUAS 6DH | TUAS 6GH | TUAS 6JH | TUAS 6KH | TUAS 6MH | UNIT |
| Marking code on the dev | /ice | | AS6D | AS6G | AS6J | AS6K | AS6M | |
| Repetitive peak reverse voltage | | V_{RRM} | 200 | 400 | 600 | 800 | 1000 | V |
| Reverse voltage, total rms value | | $V_{R(RMS)}$ | 140 | 280 | 420 | 560 | 700 | V |
| Forward current | | I _F | 6 | | | | Α | |
| Surge peak forward current single half sinewave superimposed on rated load $t = 8.3 \text{ms}$ | | | | | 140 | | | - A |
| | | I _{FSM} | | | 300 | | | |
| Junction temperature | | TJ | -55 to +150 | | | °C | | |
| Storage temperature | | T _{STG} | -55 to +150 | | | °C | | |

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| THERMAL PERFORMANCE | | | | | |
|--|------------------|-----|------|--|--|
| PARAMETER | SYMBOL | TYP | UNIT | | |
| Junction-to-lead thermal resistance | $R_{\Theta JL}$ | 5 | °C/W | | |
| Junction-to-ambient thermal resistance | $R_{\Theta JA}$ | 45 | °C/W | | |
| Junction-to-case thermal resistance | R _{eJC} | 7.9 | °C/W | | |

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

| ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted) | | | | | | |
|--|--------------------|---|-----------------|------|------|------|
| PARAMETER | | CONDITIONS | SYMBOL | TYP | MAX | UNIT |
| Forward voltage ⁽¹⁾ | | I _F = 3A, T _J = 25°C | V _F | 0.91 | - | V |
| | | I _F = 6A, T _J = 25°C | | 0.98 | 1.10 | V |
| | | I _F = 3A, T _J = 125°C | | 0.80 | - | V |
| | | I _F = 6A, T _J = 125°C | | 0.88 | - | V |
| Reverse current @ rated V _R ⁽²⁾ | | T _J = 25°C | I _R | - | 5 | μΑ |
| | | T _J = 125°C | | 13 | - | μΑ |
| TUAS6DH TUAS6GH Junction capacitance TUAS6JH | | 1MHz, V _R = 4.0V | C, _J | 43 | - | pF |
| | TUAS6KH TUAS6MH | , | | 39 | - | - |

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

| ORDERING INFORMATION | | | | | |
|------------------------------|--------------------|---------------------|--|--|--|
| ORDERING CODE ⁽¹⁾ | PACKAGE | PACKING | | | |
| TUAS6xH | TO-277A (SMPC4.6U) | 6,000 / Tape & Reel | | | |

Notes:

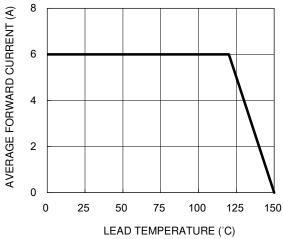
1. "x" define voltage from 200V(TUAS6DH) to 1000V(TUAS6MH)

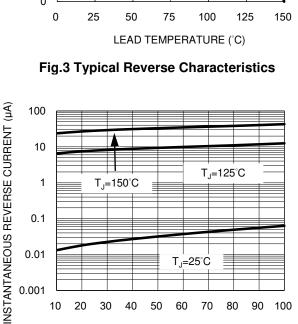


CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve





0.01

0.001

20 30 40 50 60 70 80

PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

T_{.1}=25°C

90

Fig.2 Typical Junction Capacitance

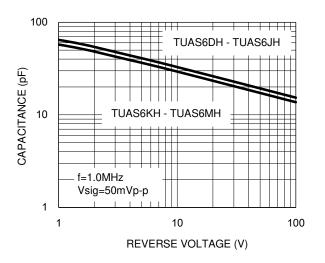


Fig.4 Typical Forward Characteristics

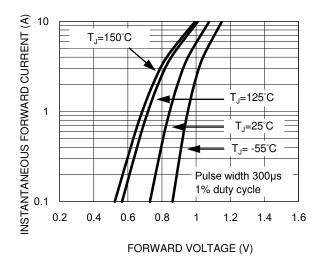
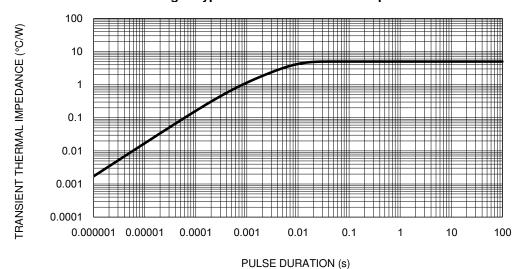


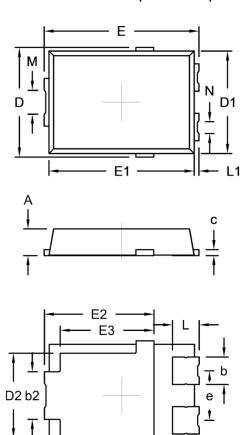
Fig.5 Typical Transient Thermal Impedance





PACKAGE OUTLINE DIMENSIONS

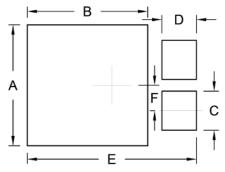
TO-277A (SMPC4.6U)



| DIM. | Unit | (mm) | Unit (inch) | | |
|--------|-------------|-------|--------------|--------|--|
| DIIVI. | Min. | Max. | Min. | Max. | |
| Α | 1.00 | 1.20 | 0.039 | 0.047 | |
| b | 1.05 | 1.35 | 0.041 | 0.053 | |
| b2 | 1.90 | 2.20 | 0.075 | 0.087 | |
| b4 | 0.75 (| NOM.) | 0.030 | (NOM.) | |
| С | 0.15 | 0.40 | 0.006 | 0.016 | |
| D | 4.45 | 4.75 | 0.175 | 0.187 | |
| D1 | 4.25 | 4.35 | 0.167 | 0.171 | |
| D2 | 3.40 | 3.70 | 0.134 | 0.146 | |
| E | 6.35 | 6.65 | 0.250 | 0.262 | |
| E1 | 6.05 | 6.15 | 0.238 | 0.242 | |
| E2 | 4.40 | 4.80 | 0.173 | 0.189 | |
| E3 | 3.94 (NOM.) | | 0.155 (NOM.) | | |
| е | 2.08 (| NOM.) | 0.082 (NOM.) | | |
| L | 0.94 | 1.24 | 0.037 | 0.049 | |
| L1 | 0.05 | 0.35 | 0.002 | 0.014 | |
| М | 0.65 | 1.15 | 0.026 | 0.045 | |
| N | 0.25 | 0.75 | 0.010 | 0.030 | |

Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

SUGGESTED PAD LAYOUT



b4

| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| Α | 4.95 | 0.195 |
| В | 4.95 | 0.195 |
| С | 1.60 | 0.063 |
| D | 1.42 | 0.056 |
| E | 6.95 | 0.274 |
| F | 1.04 | 0.041 |

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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